



USC170R560A

Power MOSFET

8A, 1700V N-CHANNEL SILICON CARBIDE PLANAR ENHANCEMENT POWER MOSFET

DESCRIPTION

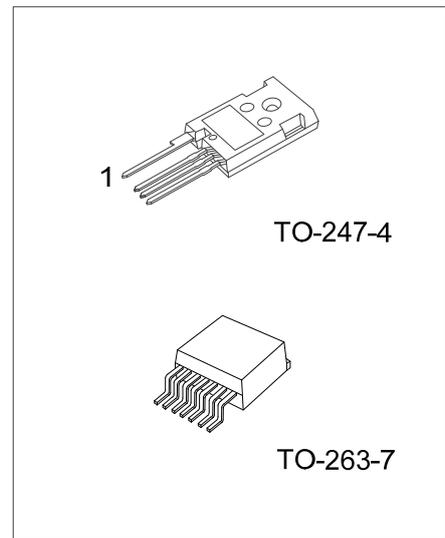
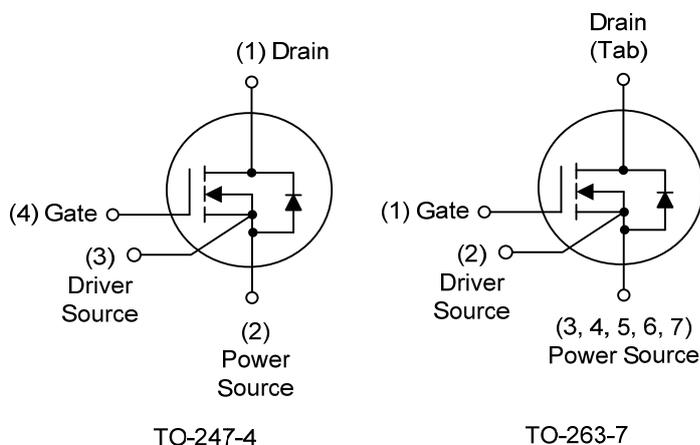
SiC The material can achieve high voltage with most carrier devices (MOSFET) with fast device structure characteristics, so it can realize the three characteristics of "high voltage", "low on resistance" and "high frequency" at the same time.

It is widely used in electric vehicle charger, industrial equipment power supply, efficient power regulator inverter and rectification part and other uses.

FEATURES

- * $R_{DS(ON)} \leq 770 \text{ m}\Omega @ V_{GS}=18\text{V}, I_D=2.0\text{A}$
- * Wide bandgap SiC MOSFET technology
- * High Speed Switching with Low Capacitances
- * Easy to Parallel
- * Low reverse recovery (Q_{rr})
- * Power Factor Correction Modules
- * Switch mode power supplies
- * DC-AC Inverters
- * On Board Charger
- * High voltage DC/DC converters

SYMBOL



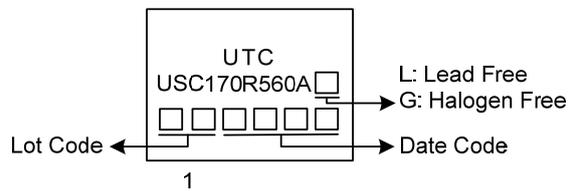
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment							Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	
USC170R560AL-TQ7-R	USC170R560AG-TQ7-R	TO-263-7	G	S	S	S	S	S	S	Tape Reel
USC170R560AL-T474-T	USC170R560AG-T474-T	TO-247-4	D	S	S	G	-	-	-	Tube

Note: Pin Assignment: D: Drain S: Source G: Gate

<p>USC170R560AG-TQ7-R</p> <p>(1) Packing Type (2) Package Type (3) Green Package</p>	<p>(1) R: Tape Reel, T: Tube (2) TQ7: TO-263-7, T474: TO-247-4 (3) G: Halogen Free and Lead Free, L: Lead Free</p>
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■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_c=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V _{DSS}	1700	V	
Gate-Source Voltage	Dynamic	V _{GSS}	-8 / +22	V	
	Static		-4 / +18	V	
Drain Current	Continuous	I _D	V _{GS} =18V T _c =25°C	8	A
			V _{GS} =18V T _c =100°C	6	A
	Pulsed (Note 2)	I _{DM}	16	A	
Power Dissipation		P _D	TO-247-4	79	W
			TO-263-7	68	W
Junction Temperature		T _J	-40 ~ +175	°C	
Storage Temperature		T _{STG}	-40 ~ +175	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

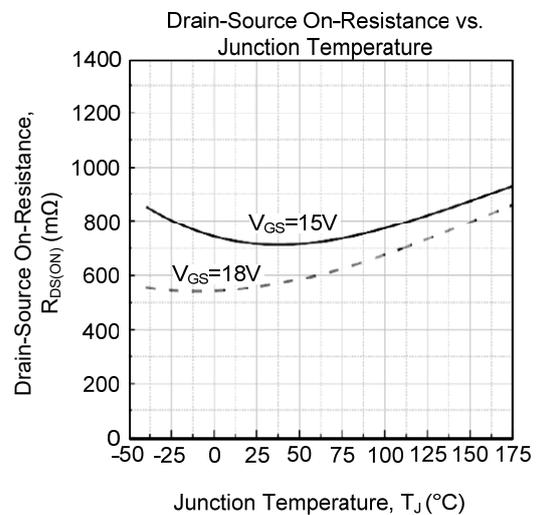
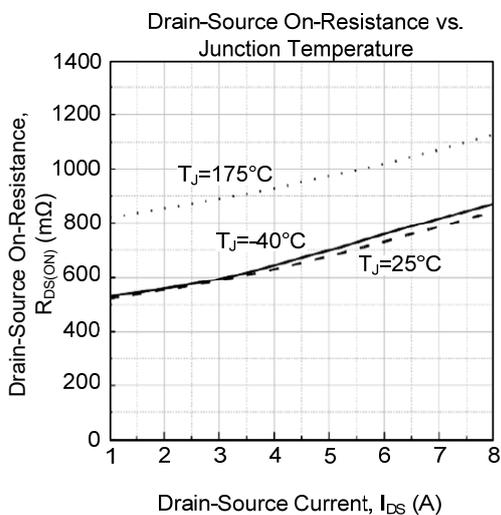
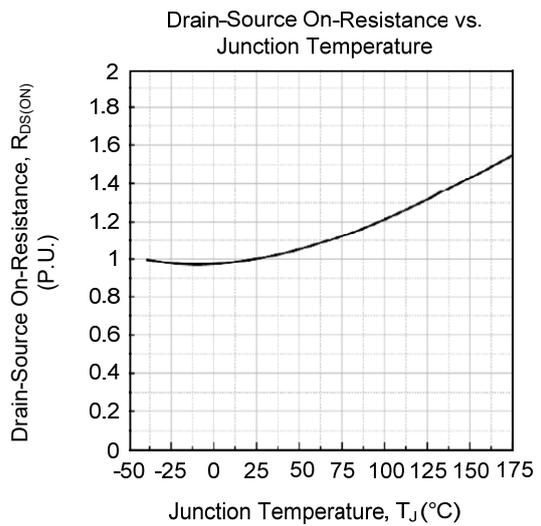
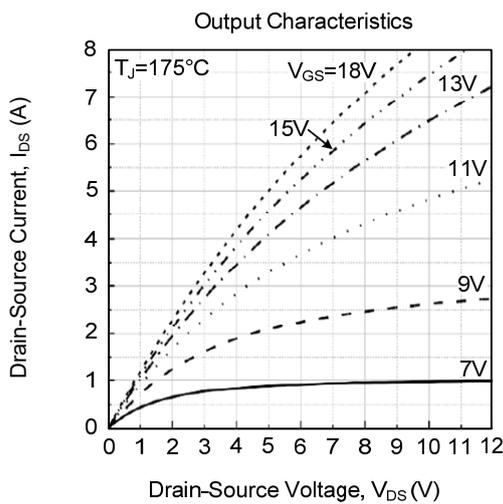
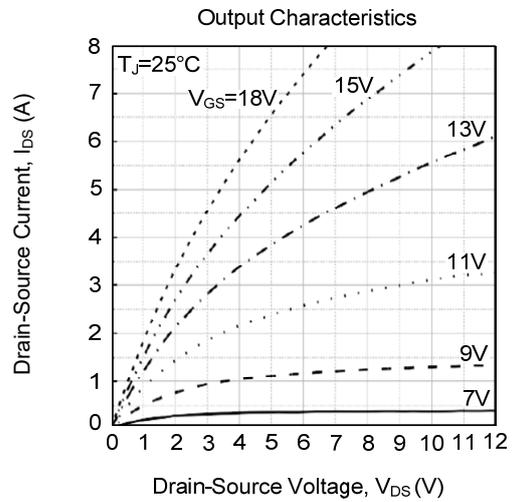
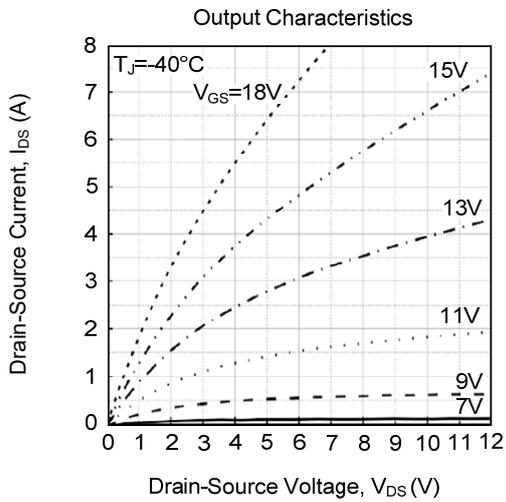
■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient		θ _{JA}	50	°C/W
Junction to Case	TO-247-4	θ _{JC}	1.89	°C/W
	TO-263-7		2.18	°C/W

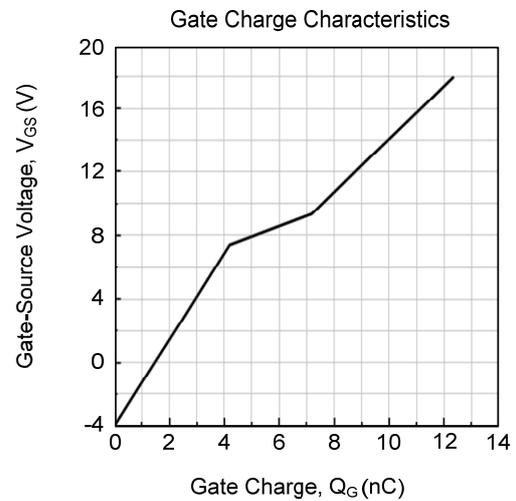
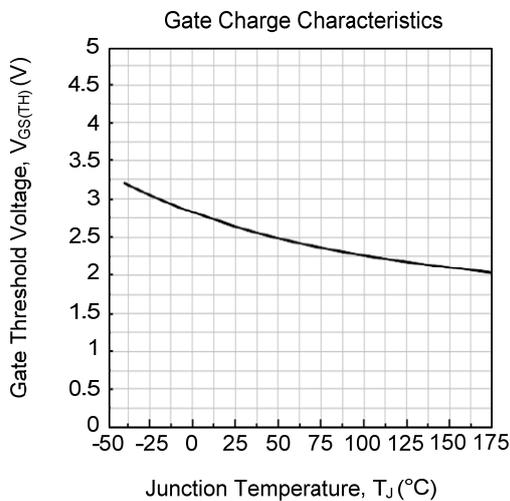
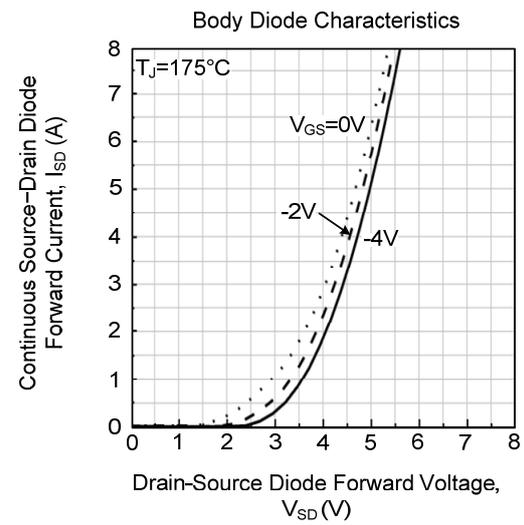
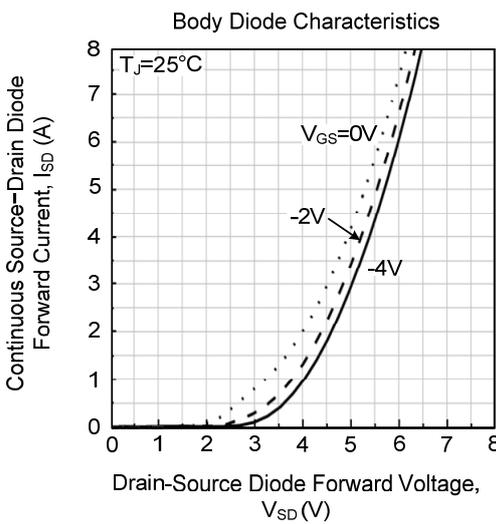
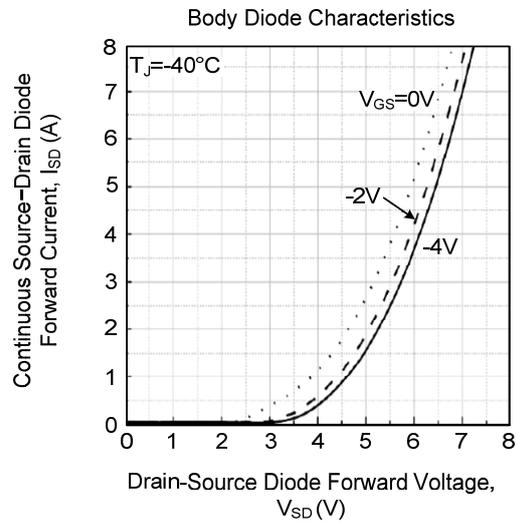
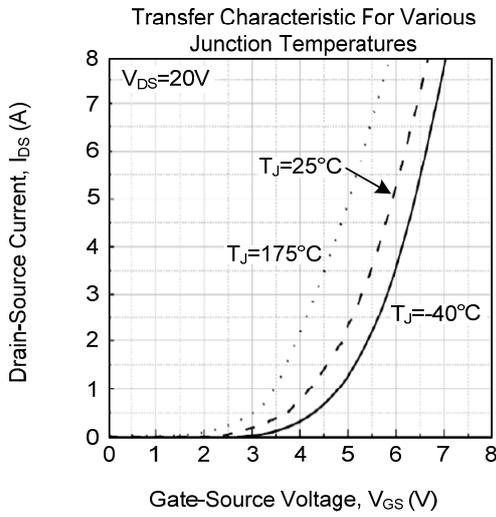
■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	B _V DSS	I _D =100μA, V _{GS} =0V	1700			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =1700V, V _{GS} =0V		1		μA
Gate- Source Leakage Current	I _{GSS}	V _{GS} =18V, V _{DS} =0V			250	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =0.5mA	2.0	2.6	4.0	V
		V _{DS} =V _{GS} , I _D =0.5mA T _J =175°C		2.0		V
Static Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =18V, I _D =2.0A		560	770	mΩ
		V _{GS} =18V, I _D =2.0A, T _J =175°C		880		mΩ
DYNAMIC PARAMETERS						
Input Capacitance	C _{ISS}	V _{DS} =1000V, V _{GS} =0V, f=1MHz		294		pF
Output Capacitance	C _{OSS}			20.5		pF
Reverse Transfer Capacitance	C _{RSS}			3.2		pF
SWITCHING PARAMETERS						
Total Gate Charge	Q _G	V _{DS} =1000V, V _{GS} =-4V / +18V, I _D =2A		20		nC
Gate to Source Charge	Q _{GS}			4		nC
Gate to Drain Charge	Q _{GD}			10		nC
Internal Gate Input Resistance	R _{G(int)}	f=1MHz		10.5		Ω
Turn-on switching energy	E _{ON}	V _{DS} =1000V, V _{GS} =-4V / +18V, I _D =2A, R _{G(ext)} =2.5Ω, L=200μH		56		μJ
Turn-off switching energy	E _{OFF}			15		μJ
Turn-ON Delay Time	t _{D(ON)}			11		ns
Rise Time	t _R			12		ns
Turn-OFF Delay Time	t _{D(OFF)}			15		ns
Fall-Time	t _F			27		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} =-4.0V, I _{SD} =2.0A		4.7		V
		V _{GS} =-4.0V, I _{SD} =2.0A, T _J =175°C		4.1		V
Continuous Diode Forward Current	I _S	V _{GS} =-4.0V		8		A
		V _{GS} =-4.0V, T _J =100°C		6		A
Body Diode Reverse Recovery Time	t _{rr}	V _{GS} =-4.0V, I _{SD} =2.0A, V _R =1000V, di _F /dt=1100A/μs		25		ns
Body Diode Reverse Recovery Charge	Q _{rr}			39		nC
Peak Reverse Recovery Current	I _{rrm}			3.5		A

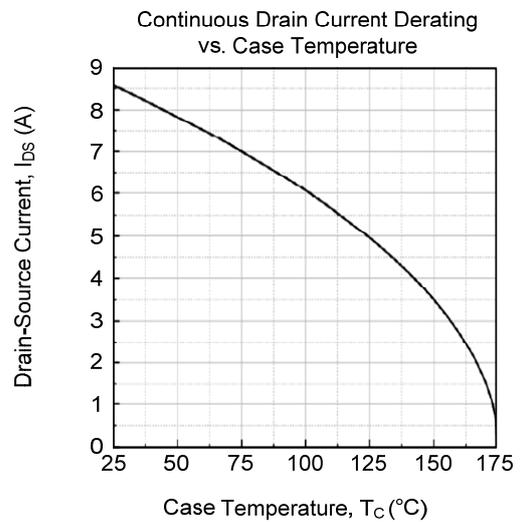
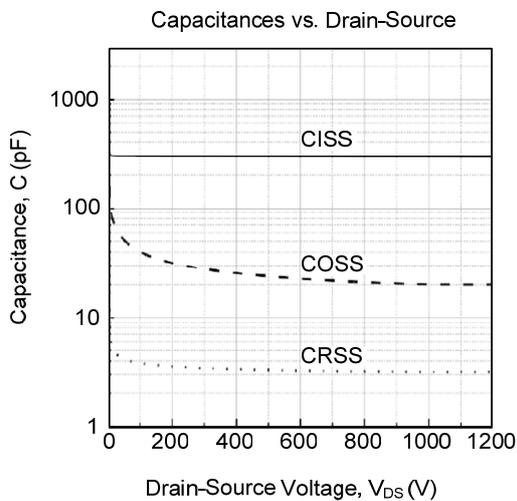
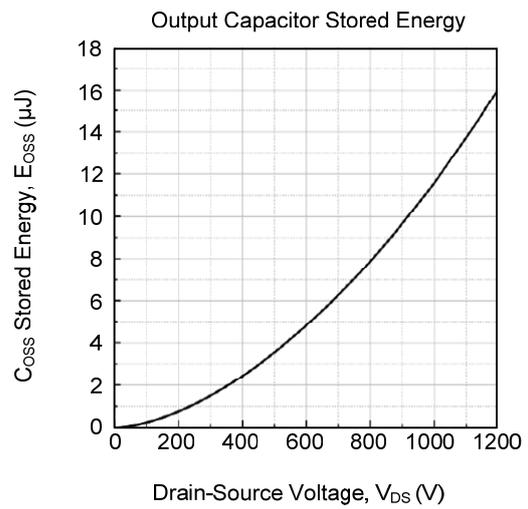
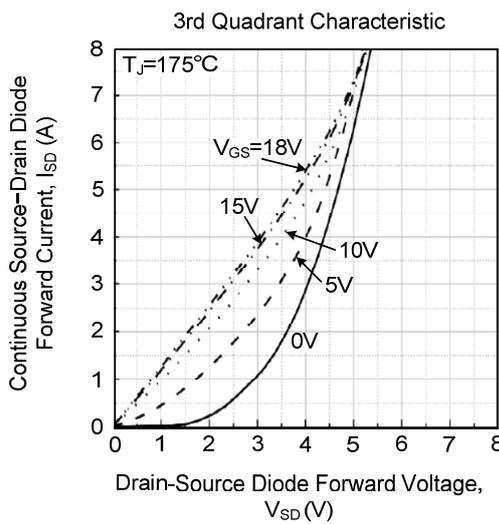
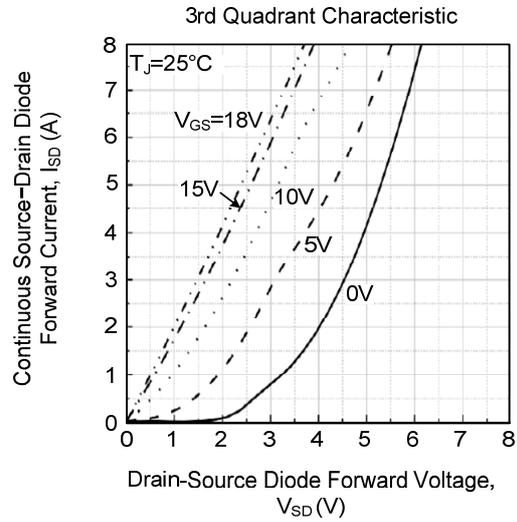
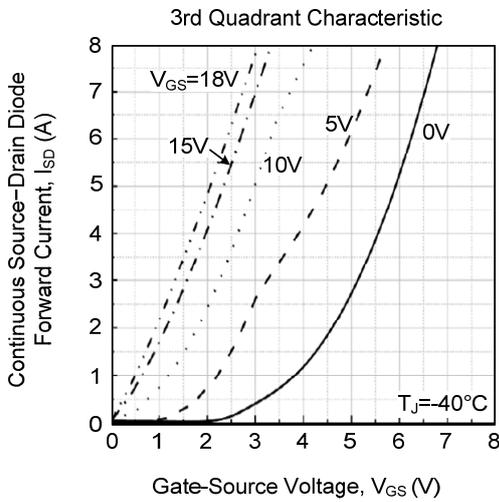
TYPICAL CHARACTERISTICS



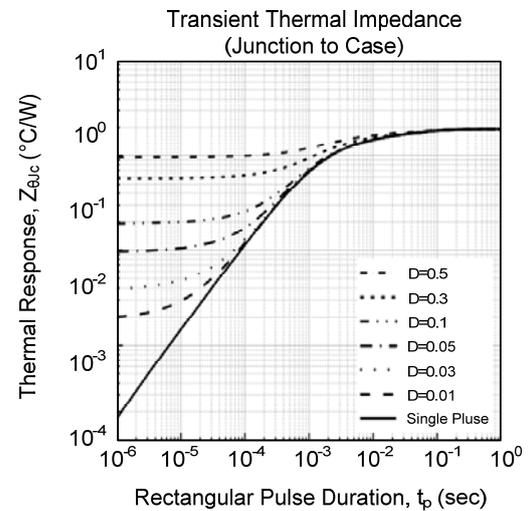
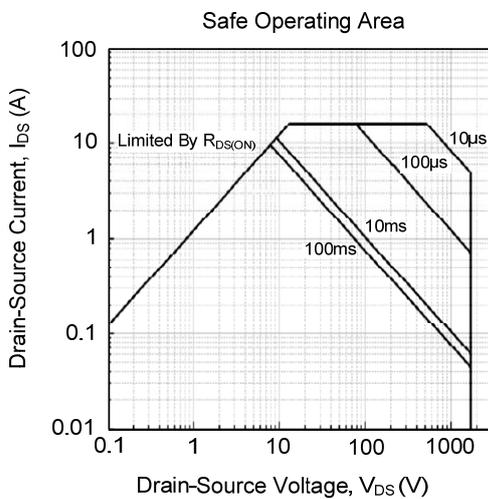
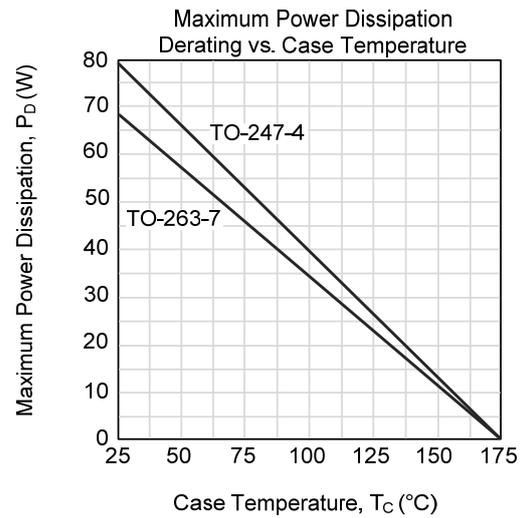
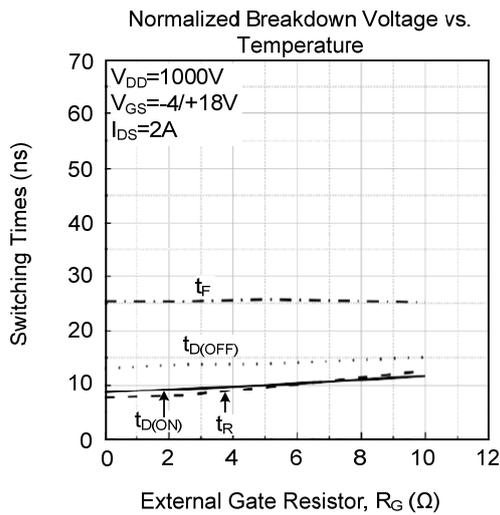
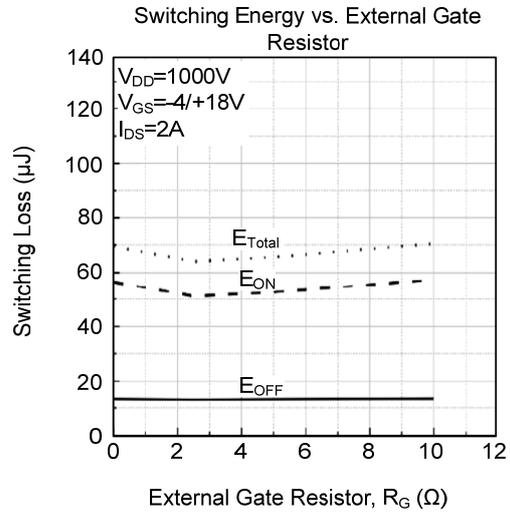
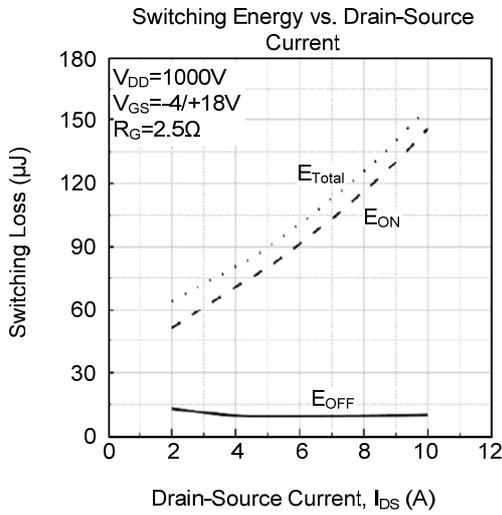
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